



N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)}	I _D T _A = +25°C
12V	$20m\Omega$ @ $V_{GS} = 4.5V$	6.6A
120	$23m\Omega$ @ $V_{GS} = 2.5V$	6.1A

Description

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}), yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- Battery Management
- Load Switch
- Battery Protection

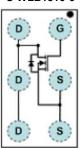
Features and Benefits

- Low Q_G & Q_{GD}
- Small Footprint
- Low Profile 0.62mm Height
- Totally Lead-Free & Full RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: U-WLB1510-6
- Terminal Connections: See Diagram Below
- Terminals: Finished SnAgCu Ball (e)
- Weight: 0.0018 grams (Approximate)

U-WLB1510-6



I op View

Ordering Information (Note 4)

Part Number	Case	Packaging
DMN1016UCB6-7	U-WLB1510-6	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

U-WLB1510-6



PW = Product Type Marking Code YM = Date Code Marking Y = Year (ex: D = 2016) M = Month (ex: 9 = September)

Date Code Key

Year	201	5	2016		2017	20	18	2019		2020	2	2021
Code	С		D		Е		F	G		Н		T
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@ $T_A = +25^{\circ}C$, unless otherwise specified.)

Characteristic		Symbol	Value	Units	
Drain-Source Voltage		V _{DSS}	12	V	
Gate-Source Voltage			V _{GSS}	±8	V
Continuous Drain Current (Note 5) V _{GS} =4.5V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I _D	5.5 4.2	А
Continuous Drain Current (Note 6) V _{GS} =4.5V	I _D	6.6 5.3	А		
Pulsed Drain Current (Note 7)		I _{DM}	30	Α	

Thermal Characteristics

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 5)	P _D	0.92	W
Total Power Dissipation (Note 6)	P _D	1.47	W
Thermal Resistance, Junction to Ambient (Note 5)	$R_{\theta JA}$	136	°C/W
Thermal Resistance, Junction to Ambient (Note 6)	$R_{\theta JA}$	94	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

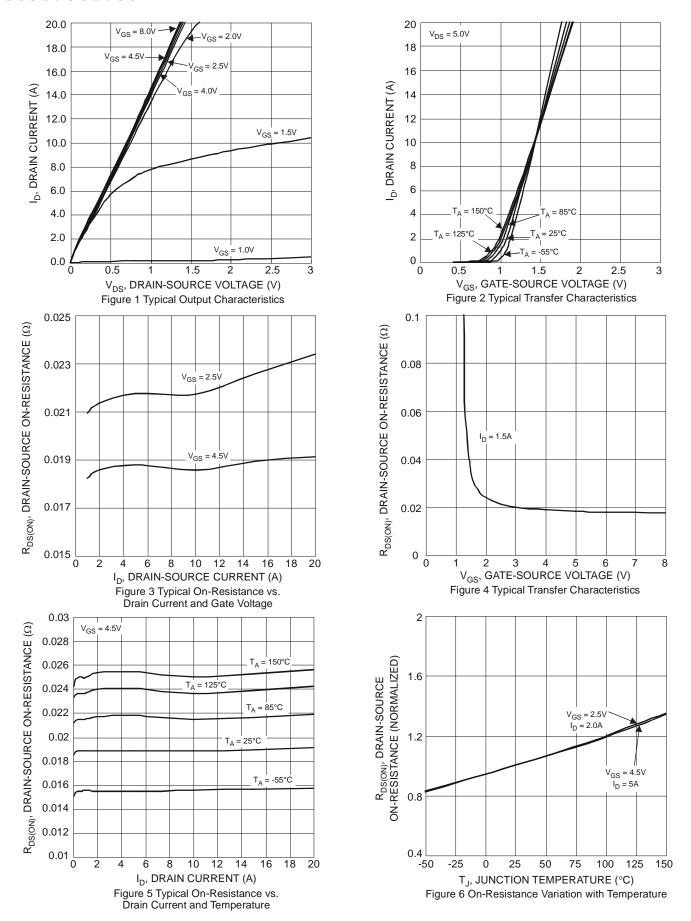
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)				•		•		
Drain-Source Breakdown Voltage		BV _{DSS}	12	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current (@	(PT _C = +25°C)	I _{DSS}	_	_	1.0	μΑ	$V_{DS} = 9.6V, V_{GS} = 0V$	
Gate-Source Leakage		I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 8V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)								
Gate Threshold Voltage		V _{GS(TH)}	0.4	0.6	1.0	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance		D	_	16	20	mΩ	$V_{GS} = 4.5V, I_D = 1.5A$	
Static Dialii-Source On-Resistance		R _{DS(ON)}	1	20	23	11122	$V_{GS} = 2.5V, I_D = 1.5A$	
Forward Transfer Admittance		Y _{FS}		14	_	S	$V_{DS} = 6V, I_{D} = 1.5A$	
Diode Forward Voltage (Note 6)		V _{SD}	_	0.7	1.0	V	$V_{GS} = 0V, I_{S} = 1.5A$	
Reverse Recovery Charge		Q_{RR}	1	8	1	nC	$V_{DD} = 6V, I_F = 1.5A,$	
Reverse Recovery Time		t _{RR}	1	43.6		ns	$di/dt = 200A/\mu s$	
DYNAMIC CHARACTERISTICS (Note 9)								
Input Capacitance		C _{ISS}	1	423	550	pF		
Output Capacitance		Coss	1	238	310	pF	$V_{DS} = 6V, V_{GS} = 0V,$ - f = 1.0MHz	
Reverse Transfer Capacitance		C _{RSS}	_	41	55	pF	1 - 1.000112	
Series Gate Resistance		R_{G}	_	3	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (4.5V)		Q_{G}	_	4.2	5.5	nC	.,	
Gate-Source Charge	Gate-Source Charge		_	0.6	_	nC	$V_{GS} = 4.5V, V_{DS} = 6V,$ $I_{D} = 1.5A$	
Gate-Drain Charge		Q_{GD}	_	0.4	_	nC	- ID = 1.5A	
Turn-On Delay Time		t _{D(ON)}	_	5	8	ns		
Turn-On Rise Time		t _R	_	10	_	ns	$V_{DS} = 6V, V_{GS} = 4.5V,$	
Turn-Off Delay Time		t _{D(OFF)}		25	40	ns	$R_G = 4\Omega$, $I_D = 1.5A$	
Turn-Off Fall Time		t _F	_	10	_	ns		

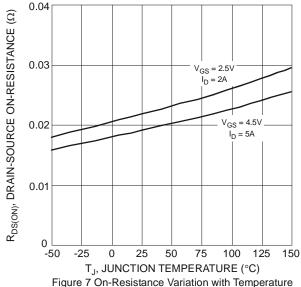
Notes:

- 5. Device mounted on FR-4 PCB with minimum recommended pad layout.
 6. Device mounted on FR4 material with 1-inch² (6.45-cm²), 2-oz (0.071-mm thick) Cu.
- Severe monitor of material with 1871 (0.43-011), 2-02
 300ms pulse, pulse duty cycle<=2%.
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to production testing.

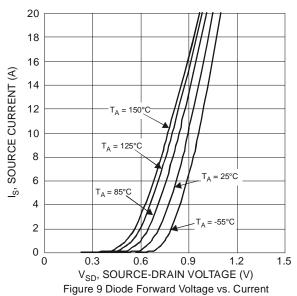


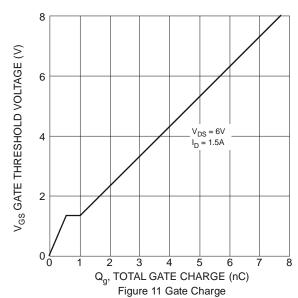












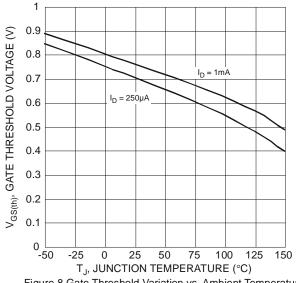
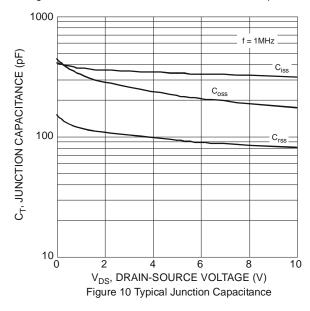


Figure 8 Gate Threshold Variation vs. Ambient Temperature



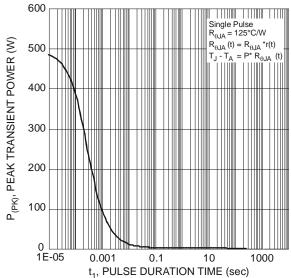
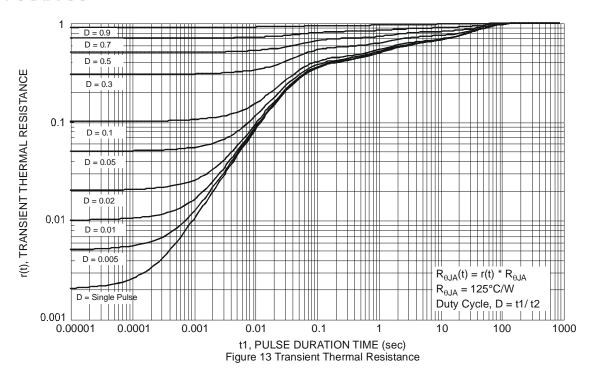


Figure 12 Single Pulse Maximum Power Dissipation



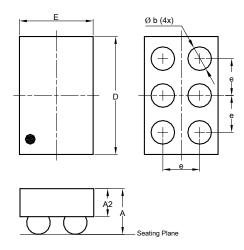




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-WLB1510-6

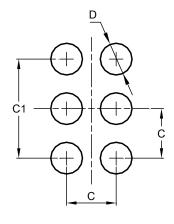


U-WLB1510-6								
Dim	Min	Max	Тур					
Α	_	0.62	_					
A2		_	0.038					
b	0.27	0.37	0.32					
D	1.40	1.50	1.50					
Е	0.90	1.00	1.00					
е	_	_	0.50					
All Dimensions in mm								

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-WLB1510-6



Dimensions	Value (in mm)				
С	0.50				
C1	1.00				
D	0.25				



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